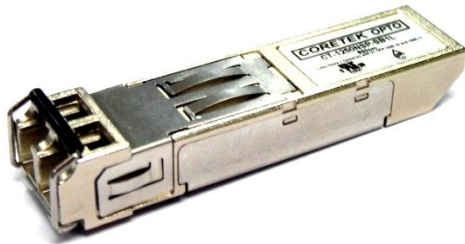
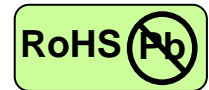


2 Mb/s IEEE C37.94 Multi-Mode Transceiver



SFP, Duplex LC Connector, 850 nm VCSEL for Multi-mode Fiber, RoHS Compliant

Digital Diagnostics Functions, Extended Operating Temperature from -40 to +85°C



Features

- 850 nm VCSEL
- Data Rate: 2 Mb/s, NRZ
- Single +3.3 V Power Supply
- RoHS Compliant and Lead-free
- AC/AC Differential Electrical Interface
- DC-coupled between VCSEL and LD driver IC.
- Compliant with Multi-Source Agreement (MSA) Small Form Factor Pluggable (SFP)
- Compliant with SFF-8472 Digital Diagnostic Monitoring Interface
- Duplex LC Connector
- Compatible with IEEE C37.94 / IEC 62843 Standard

Applications

- IEEE C37.94 / IEC 62843
- Multi-mode fiber links
- Optical-Electrical Interface Conversion

Description

The CT-0155NSP-SB2L-E 2M from Coretek Opto Corp. is the high performance and cost-effective module for serial optical data communication applications specified for data-rates 2Mb/s. It operates with a +3.3 V power supply. The module is intended for multi-mode fiber, operates at a nominal wavelength of 850 nm and complies with Multi-Source Agreement (MSA) Small Form Factor Pluggable (SFP). Each module is integrated digital diagnostics functions via an I²C serial interface.

The module is a duplex LC connector transceiver designed to provide an IEEE C37.94 compliant link for 2 Mb/s short reach applications. The characterization is performed in accordance to Telcordia Specification GR-468-CORE.

EMC

Most equipment utilizing high-speed transceivers will be required to meet the following requirements:

- 1) FCC in the United States
- 2) CENELEC EN55022 (CISPR 22) in Europe

To assist the customer in managing the overall equipment EMC performance, the transceivers have been designed to satisfy FCC class B limits and provide good immunity to radio-frequency electromagnetic fields.

Eye Safety

This laser based single mode transceiver is a CLASS 1 LASER PRODUCT, Hazard level 1. It complies with IEC 60825-1 Ed.2: 2007-03 and FDA performance standards for laser products (21 CFR 1040.10 and 1040.11) except for deviations pursuant to Laser Notice 50, dated June 24, 2007.

2 Mb/s IEEE C37.94 Multi-Mode Transceiver



Product Information

Model Number	Operating Voltage & SD Output	Distance	Wavelength	Output Power	Sensitivity
CT-0155NSP-SB2L-E 2M	3.3 V TTL AC/AC	2 km	850 nm	-16 ~ -13 dBm	\leq -32 dBm

ABSOLUTE MAX RATINGS

PARAMETER	SYMBOL	MIN	MAX	UNIT	NOTE
Storage Temperature	T _S	-40	85	°C	
Supply Voltage	V _{CC}	0	6	V	

OPERATING CONDITIONS

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE
Case Operating Temperature	T _C	-40		85	°C	
Supply Voltage	V _{CC}	3.1		3.5	V	
Data Input Voltage Swing	V _{ID}	400		1600	mV	

ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	MIN	MAX	UNIT	NOTE
Transmitter					
Transmitter Supply Current	I _{CCT}		140	mA	
Tx_Disable Input Voltage - Low	V _{IL}	0	0.8	V	
Tx_Disable Input Voltage - High	V _{IH}	2.0	V _{CC}	V	
Tx_Fault Output Voltage - Low	V _{OL}	0	0.8	V	
Tx_Fault Output Voltage - High	V _{OH}	2.0	V _{CC}	V	
Receiver					
Receiver Supply Current	I _{CCR}		100	mA	
Receiver Data Output Differential Voltage	V _{OD}	0.4	1.3	V	
Rx_LOS Output Voltage - Low	V _{OL}	0	0.8	V	
Rx_LOS Output Voltage - High	V _{OH}	2.0	V _{CC}	V	
MOD_DEF (1) , MOD_DEF (2) - Low	V _{IL}	-0.6	V _{CC} × 0.3	V	
MOD_DEF (1) , MOD_DEF (2) - High	V _{IH}	V _{CC} × 0.7	V _{CC} + 0.5	V	

TRANSMITTER ELECTRO-OPTICAL CHARACTERISTICS

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNIT	NOTE
Optical Output Power	P _o	-19		-11	dBm	1
Optical Output Power	P _o	-23		-11	dBm	2
Extinction Ratio	ER	12			dB	2Mb/s
Center Wavelength	λ_c	830	850	860	nm	
Spectral Width (RMS)	$\Delta \lambda$			1	nm	
Optical Rise time (10%-90%)	t _r			10	ns p-p	
Optical Fall time (10%-90%)	t _f			10	ns p-p	
Output Eye		Compliant with ITU recommendation G.957				

* The laser shutdown is deactivated.

2 Mb/s IEEE C37.94 Multi-Mode Transceiver



RECEIVER ELECTRO-OPTICAL CHARACTERISTICS

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNIT	NOTE
Maximum Input Optical Power	P_{max}	-3			dBm	3
Receiver Sensitivity	P_{min}			-32	dBm	3
Operating Wavelength	λ	770		860	nm	
Loss of Signal - Asserted	P_A	-45			dBm	
Loss of Signal - Deasserted	P_D			-31	dBm	
Loss of Signal -Hysterisis	$P_D - P_A$	0.5			dB	

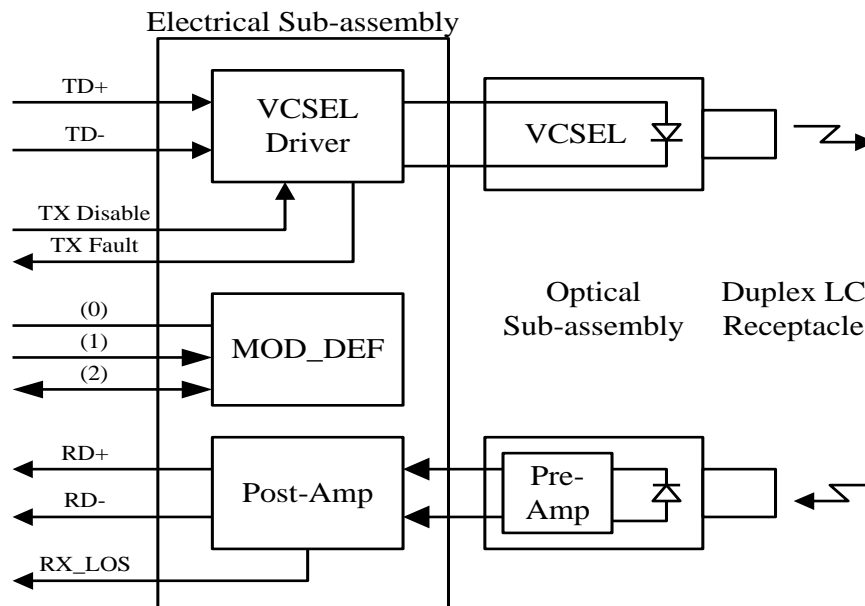
Notes:

1. Measured average power coupled into 62.5/125 μm , 0.275 NA graded index multi-mode fiber.
2. Measured average power coupled into 50/125 μm , 0.2 NA graded index multi-mode fiber.
3. Measured with 2^7-1 PRBS at $\text{BER} < 10^{-10}$

TIMING CHARACTERISTICS

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNIT	NOTE
TX_DISABLE Assert Time	t_{off}			10	μs	
TX_DISABLE Negate Time	t_{on}			1	ms	
Time to initialize, include reset of TX_FAULT	t_{init}			300	ms	
TX_FAULT from fault to assertion	t_{fault}			100	μs	
TX_DISABLE time to start reset	t_{reset}	10			μs	
Receiver Loss of Signal Assert Time (off to on)	t_{A,RX_LOS}			100	μs	
Receiver Loss of Signal Assert Time (on to off)	t_{D,RX_LOS}			100	μs	

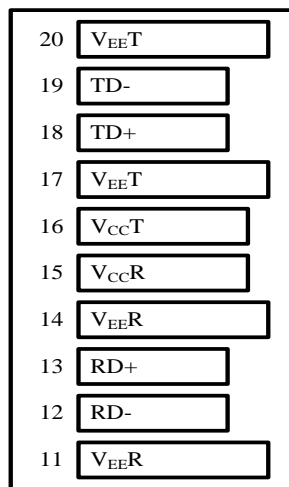
BLOCK DIAGRAM OF TRANSCEIVER



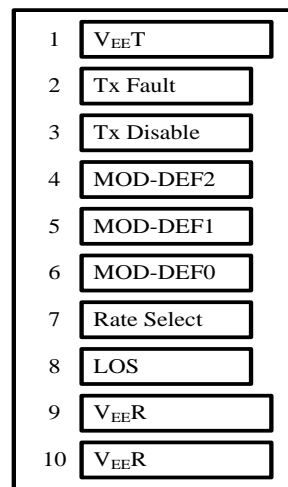
2 Mb/s IEEE C37.94 Multi-Mode Transceiver



PIN OUT DIAGRAM OF TRANSCEIVER



Top of Board



Bottom of Board (As Viewed through Top of Board)

PIN OUT TABLE

Pin	Symbol	Functional Description
1	VeeT	Transmitter Ground
2	TX Fault	Transmitter Fault Indication (Not Connected)
3	TX Disable	Transmitter Disable – Module disables on high or open
4	MOD-DEF(2)	Module Definition 2 – Two wire serial ID interface
5	MOD-DEF(1)	Module Definition 1 – Two wire serial ID interface
6	MOD-DEF(0)	Module Definition 0 – Grounded in module
7	Rate Select	Not Connected
8	LOS	Loss of Signal
9	VeeR	Receiver Ground
10	VeeR	Receiver Ground
11	VeeR	Receiver Ground
12	RD-	Inverse Received Data Out
13	RD+	Received Data Out
14	VeeR	Receiver Ground
15	VccR	Receiver Power
16	VccT	Transmitter Power
17	VeeT	Transmitter Ground
18	TD+	Transmitter Data In
19	TD-	Inverse Transmitter Data In
20	VeeT	Transmitter Ground

2 Mb/s IEEE C37.94 Multi-Mode Transceiver



EEPROM Serial ID Memory Contents

Table 1 - EEPROM Serial ID Memory Contents (A0h)

Addr.	Field Size (Bytes)	Name of Field	Hex	Description
00	1	Identifier	03	SFP
01	1	Ext. Identifier	04	MOD4
02	1	Connector	07	LC
03 ~ 10	8	Transceiver Codes	00 00 00 00 00 00 00 00	
11	1	Encoding	03	NRZ
12	1	BR, Nominal	02	
13	1	Reserved	00	
14	1	Length (SMF)-km	00	
15	1	Length (SMF)-100 m	00	
16	1	Length (50 μ m, OM2)	C8	2 km
17	1	Length (62.5 μ m, OM1)	C8	2 km
18	1	Length (copper)	00	
19	1	Reserved	00	
20 ~ 35	16	Vendor Name	43 4F 52 45 54 45 4B 20 20 20 20 20 20 20 20 20	CORETEK
36	1	Reserved	00	
37 ~ 39	3	OUI Code	00 00 00	
40 ~ 55	16	Vendor PN	43 54 2D 30 31 35 35 4E 53 50 2D 53 42 32 4C 45	CT-0155NSP-SB2LE
56 ~ 59	4	Vendor Rev	30 30 30 31	0001
60 ~ 61	2	Wavelength	03 52	850 nm
62	1	Reserved	00	
63	1	CC BASE	XX	Check sum
64 ~ 65	2	Options	00 1A	LOS, TX_FAULT and TX_DISABLE
66	1	BR max	00	
67	1	BR min	00	
68 ~ 83	16	Vendor SN	xxxxxxxxxxxxxxxx	
84 ~ 91	8	Date code		

2 Mb/s IEEE C37.94 Multi-Mode Transceiver



92	1	Diagnostic Monitoring Type	68	
93	1	Enhanced Options	90	
94	1	SFF-8472	01	Rev 9.3 of SFF-8472 Compliance
95	1	CC BASE	XX	Check sum
96 ~ 127	32	Vendor Specific		

Table 2- EEPROM Serial ID Memory Contents (A2h)

Addr.	Field Size (Bytes)	Name of Field	Hex	Description
00 ~ 07	8	Temperature Alarm/Warning (°C)	6E 00 D8 00 64 00 DD 00	Alarm_H/L : 110/-40 Warning_H/L : 100/-35
08 ~ 15	8	Voltage Alarm/Warning (V)	8C A0 75 30 88 B8 79 18	Alarm_H/L : 3.6/3 Warning_H/L : 3.5/3.1
16 ~ 23	8	BiasCurrent Alarm/Warning (mA)	17 70 00 FA 13 88 02 58	Alarm_H/L : 12/0.5 Warning_H/L : 10/1.2
24 ~ 31	8	Tx Power Alarm/Warning (dBm)	03 E8 00 27 03 1A 00 32	Alarm_H/L : -10/-24 Warning_H/L : -11/-23
32 ~ 39	8	Rx Power Alarm/Warning (dBm)	18 A5 00 05 13 94 00 06	Alarm_H/L : -2/-33 Warning_H/L : -3/-32

Monitoring Specification

The digital diagnostic monitoring interface also defines another 256-byte memory map in EEPROM, which makes use of the 8 bit address 1010001X (A2h). Please see Figure 1. For detail EEPROM information, please refer to the related document of SFF-8472 Rev 9.5. The monitoring specification of this product is described in Table 3.

Figure 3.1: Digital Diagnostic Memory Map

Specific Data Field Descriptions

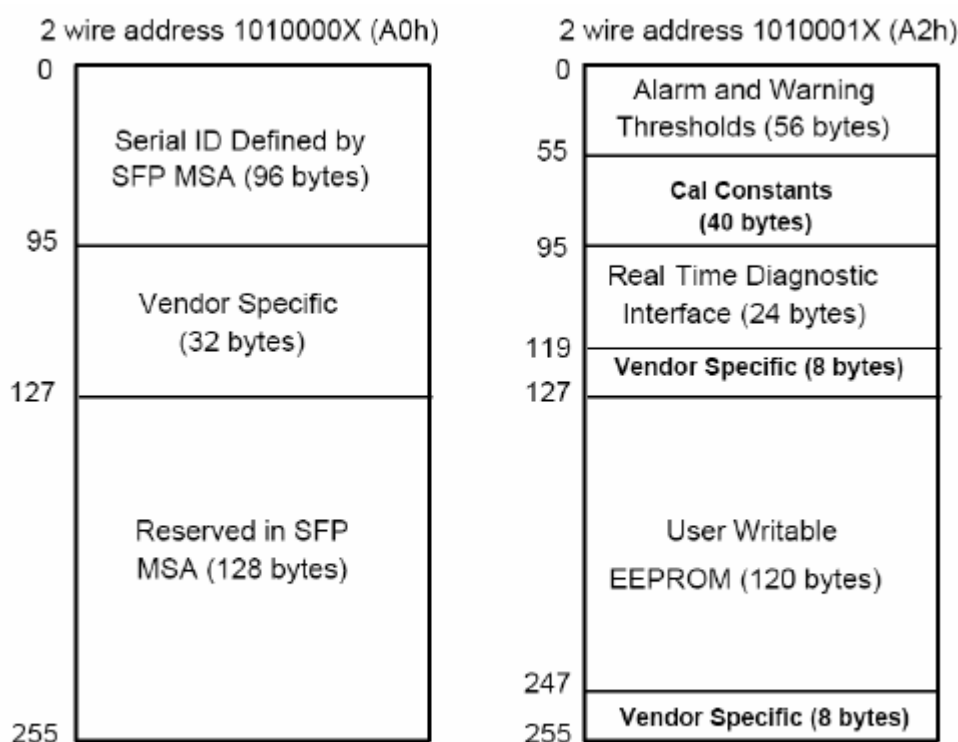


Figure 1, EEPROM Memory Map Specific Data Field Descriptions

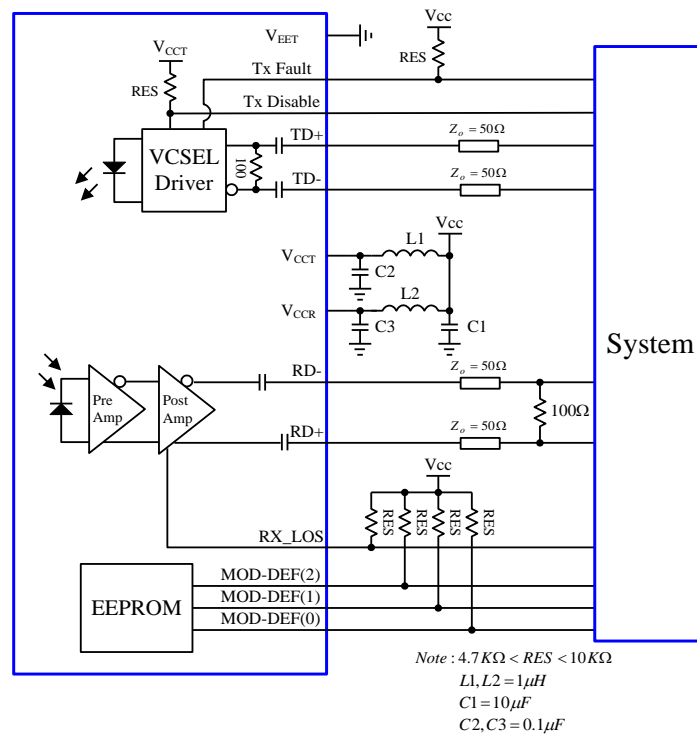
Table 3 - Monitoring Specification

Parameter	Range	Accuracy	Calibration
Temperature	-40°C to 85°C	±3°C	Internal
Voltage	3.0 to 3.6 V	±3%	Internal
Bias Current	0 to 12 mA	±10%	Internal
TX Power	-16 to -13 dBm	±3 dB	Internal
RX Power	-32 to -3 dBm	±3 dB	Internal

2 Mb/s IEEE C37.94 Multi-Mode Transceiver

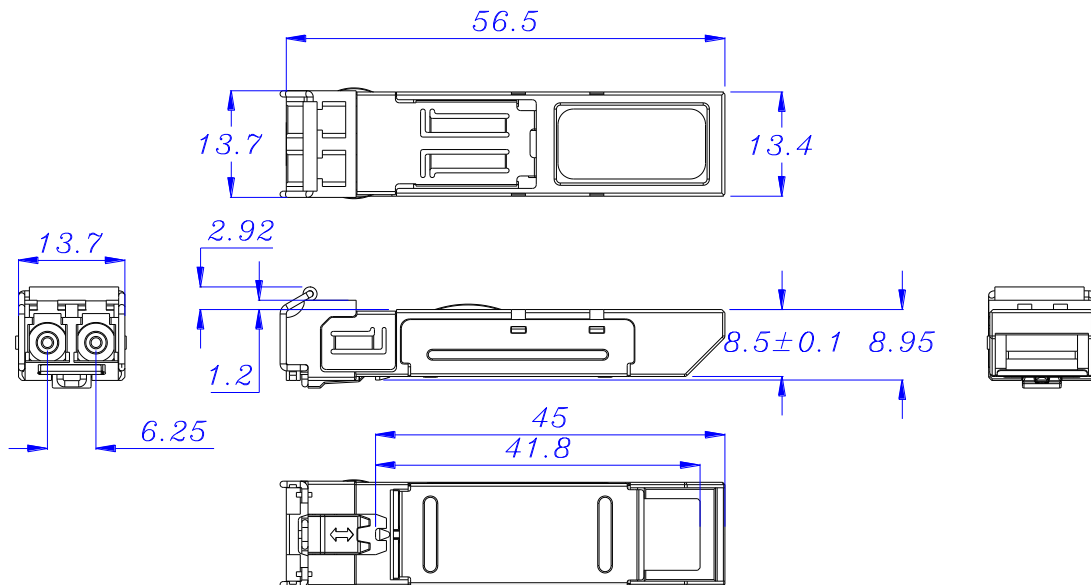


RECOMMENDED CIRCUIT SCHEMATIC



MECHANICAL DIMENSIONS

Units in mm



All dimensions are $\pm 0.2\text{mm}$ unless otherwise specified.

Claim:

CORETEK Opto Corp. reserves the right to make changes in the specification described hereinafter without prior notice.